

**PROVISIONAL GRADE CARD**

Name : SHAIK THOTTI MAHAMMAD ALI

Enrolment No. : MT23MVD001

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AA				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	AA				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AA				
ENL513	IC DESIGN WITH HDL (DC)	4	AA				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	AA				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AA				

SGPA				CGPA	CGPA			
Credit	EGP	SGPA	Credit		EGP	CGPA		
22	220	10.00	22	220	10.00			
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0	
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22	

**Note :** THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE Medium of Instruction : English

Abbreviations : Cr - Credits, Gr - Grade, AU - Audit, EGP - Earned Grade Points

SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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( This Statement is subject to correction, if any )

Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : AAYUSH TAMRAKAR

Enrolment No. : MT23MVD003

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BC				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	CD				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	CD				
ENL513	IC DESIGN WITH HDL (DC)	4	BC				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BC				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	BC				

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	138	6.27		22	138	6.27
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : SHIRAMSHETTY JITESH NATH

Enrolment No. : MT23MVD004

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2023**

ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AB
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BC
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BB
ENL513	IC DESIGN WITH HDL (DC)	4	AA
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BB
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	BB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	183	8.32		22	183	8.32
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : MAHESH SHANKARRAO SALAME

Enrolment No. : MT23MVD005

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	CD				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	CC				
ENL513	IC DESIGN WITH HDL (DC)	4	BC				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CD				

SGPA	Credit		EGP		SGPA		CGPA	Credit		EGP		CGPA			
	16		92		5.75			16		92		5.75			
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0	AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

Medium of Instruction : English

Abbreviations : Cr - Credits, Gr - Grade, AU - Audit, EGP - Earned Grade Points

SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : GUDIVADA CHANDRA MOHAN

Enrolment No. : MT23MVD006

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AB				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BC				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BB				
ENL513	IC DESIGN WITH HDL (DC)	4	AB				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BB				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AB				

SGPA				CGPA			
Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA	
22	182	8.27		22	182	8.27	
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

**Note :** THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE Medium of Instruction : English

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : VAILLA SPOORTHY PRIYA

Enrolment No. : MT23MVD007

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AB				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BB				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB				
ENL513	IC DESIGN WITH HDL (DC)	4	BB				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	AB				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AA				

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	193	8.77		22	193	8.77
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : N A AAKAASH KUMARAN

Enrolment No. : MT23MVD008

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2023**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BC
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BC
ENL513	IC DESIGN WITH HDL (DC)	4	AA
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	AB

SGPA	Credit			EGP			SGPA			CGPA	Credit			EGP			CGPA		
	16			132			8.25				16			132			8.25		
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0												
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16												

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Medium of Instruction : English

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SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : VEGI DORA APPALANAIDU

Enrolment No. : MT23MVD009

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AB				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	AB				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB				
ENL513	IC DESIGN WITH HDL (DC)	4	AB				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BB				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AB				

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	194	8.82		22	194	8.82
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**



**PROVISIONAL GRADE CARD**

Name : NAVEEN KUMAR MODUGU

Enrolment No. : MT23MVD010

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BB				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	CC				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	CC				
ENL513	IC DESIGN WITH HDL (DC)	4	BB				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CC				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	BB				

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	152	6.91		22	152	6.91
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : ABDUL BASHEER

Enrolment No. : MT23MVD011

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BB				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BB				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB				
ENL513	IC DESIGN WITH HDL (DC)	4	BB				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CC				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AA				

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	178	8.09		22	178	8.09
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : AKASH KUMAR DIXIT

Enrolment No. : MT23MVD012

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AB				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	AA				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AA				
ENL513	IC DESIGN WITH HDL (DC)	4	AB				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	AB				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AB				

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	206	9.36		22	206	9.36
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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Abbreviations : Cr - Credits, Gr - Grade, AU - Audit, EGP - Earned Grade Points

SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : KOMMU VIJAYA RAJU

Enrolment No. : MT23MVD013

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BB				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BC				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BB				
ENL513	IC DESIGN WITH HDL (DC)	4	BB				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BC				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AB				

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	171	7.77		22	171	7.77
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : ALOK KUMAR

Enrolment No. : MT23MVD015

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BC				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	AA				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB				
ENL513	IC DESIGN WITH HDL (DC)	4	AB				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BC				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AB				

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	188	8.55		22	188	8.55
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : SINGH KANHAIYA TARKESHWAR

Enrolment No. : MT23MVD016

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2023</b>							
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BB				
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	AB				
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BB				
ENL513	IC DESIGN WITH HDL (DC)	4	BB				
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	AB				
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AA				

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	22	190	8.64		22	190	8.64
DE 6	DC 16	HM 0	OC 0	DE 6	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 22	AU 0	ES 0	BS 0	Total 22

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : POOJA SINGH PARIHAR

Enrolment No. : MT23MVD017

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2023**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	AA
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AA
ENL513	IC DESIGN WITH HDL (DC)	4	BB
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BC

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	16	140	8.75		16	140	8.75
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

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**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : KOLACHALAMA MANASA

Enrolment No. : MT23MVD018

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2023**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	AB
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AA
ENL513	IC DESIGN WITH HDL (DC)	4	AA
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	AB

SGPA	Credit		EGP		SGPA		CGPA	Credit		EGP		CGPA	
	16		152		9.50			16		152		9.50	
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0						
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16						

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

Medium of Instruction : English

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SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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**Asst. Registrar (Examination)**



**PROVISIONAL GRADE CARD**Name : **DIPSHIKA LOMESH KHOBRAGADE**Enrolment No. : **MT23MVD019**Branch : **V L S I DESIGN**Degree : **Master of Technology**

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2023**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BC
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB
ENL513	IC DESIGN WITH HDL (DC)	4	BB
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BC

SGPA	Credit			EGP			SGPA			CGPA	Credit			EGP			CGPA		
	16			124			7.75				16			124			7.75		
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0												
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16												

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Abbreviations : Cr - Credits, Gr - Grade, AU - Audit, EGP - Earned Grade Points

SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : DEUSH UDAY HINGE

Enrolment No. : MT23MVD020

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2023**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	CD
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	CD
ENL513	IC DESIGN WITH HDL (DC)	4	CC
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CD

SGPA	Credit		EGP		SGPA		CGPA	Credit		EGP		CGPA	
	16	84	5.25	CGPA	16	84		5.25					
DE 0	DC 16	HM 0	OC 0	0	DE 0	DC 16	HM 0	OC 0	0				
AU 0	ES 0	BS 0	Total	16	AU 0	ES 0	BS 0	Total	16				

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**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : ABHISHEK SINGH RATHORE

Enrolment No. : MT22MVD001

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2022**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BC
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BB
ENL513	IC DESIGN WITH HDL (DC)	4	BC
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	16	120	7.50		16	120	7.50
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	AB
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BB
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	BB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	12	102	8.50		47	364	7.74
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

**SPRING (Jan - May) 2023**

ENL504	VLSI SYSTEM DESIGN (DE)	3	CC
ENL518	ANALOG IC DESIGN (DC)	4	AB
ENL520	NANOELECTRONICS (DC)	4	BC
ENL522	MEMS AND NEMS (DE)	3	BB
ENL546	EMBEDDED SYSTEMS (DE)	3	BC
ENP522	MEMS AND NEMS (DE)	1	BC
ENP546	EMBEDDED SYSTEMS (DE)	1	BB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	19	142	7.47		35	262	7.49
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

Medium of Instruction : English

Abbreviations : Cr - Credits, Gr - Grade, AU - Audit, EGP - Earned Grade Points

SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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( This Statement is subject to correction, if any )

Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : KANDREGULA VAMSI

Enrolment No. : MT22MVD002

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2022**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BB
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BB
ENL513	IC DESIGN WITH HDL (DC)	4	BC
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CC

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	16	116	7.25		16	116	7.25
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	AB
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BB
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	12	105	8.75		47	352	7.49
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

**SPRING (Jan - May) 2023**

ENL504	VLSI SYSTEM DESIGN (DE)	3	BC
ENL518	ANALOG IC DESIGN (DC)	4	BC
ENL520	NANOELECTRONICS (DC)	4	CC
ENL522	MEMS AND NEMS (DE)	3	BC
ENL542	CMOS RF DESIGN (DE)	3	BC
ENP522	MEMS AND NEMS (DE)	1	AB
ENP542	CMOS RF DESIGN (DE)	1	BC

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	19	131	6.89		35	247	7.06
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

Medium of Instruction : English

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SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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( This Statement is subject to correction, if any )

Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : SUJOY PAUL  
Branch : V L S I DESIGN

Enrolment No. : MT22MVD003  
Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr																																																																
<b>AUTUMN (July-Nov)2022</b>				<b>SPRING (Jan - May) 2023</b>																																																																			
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	AA	ENL504	VLSI SYSTEM DESIGN (DE)	3	BC																																																																
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BB	ENL518	ANALOG IC DESIGN (DC)	4	BC																																																																
ENL513	IC DESIGN WITH HDL (DC)	4	AB	ENL520	NANOELECTRONICS (DC)	4	BB																																																																
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BB	ENL522	MEMS AND NEMS (DE)	3	AB																																																																
<table border="1"> <thead> <tr> <th>SGPA</th> <th>Credit</th> <th>EGP</th> <th>SGPA</th> <th>CGPA</th> <th>Credit</th> <th>EGP</th> <th>CGPA</th> </tr> </thead> <tbody> <tr> <td></td> <td>16</td> <td>140</td> <td>8.75</td> <td></td> <td>16</td> <td>140</td> <td>8.75</td> </tr> <tr> <td>DE 0</td> <td>DC 16</td> <td>HM 0</td> <td>OC 0</td> <td>DE 0</td> <td>DC 16</td> <td>HM 0</td> <td>OC 0</td> </tr> <tr> <td>AU 0</td> <td>ES 0</td> <td>BS 0</td> <td>Total 16</td> <td>AU 0</td> <td>ES 0</td> <td>BS 0</td> <td>Total 16</td> </tr> </tbody> </table>				SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA		16	140	8.75		16	140	8.75	DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0	AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16	<table border="1"> <thead> <tr> <th>SGPA</th> <th>Credit</th> <th>EGP</th> <th>SGPA</th> <th>CGPA</th> <th>Credit</th> <th>EGP</th> <th>CGPA</th> </tr> </thead> <tbody> <tr> <td></td> <td>19</td> <td>149</td> <td>7.84</td> <td></td> <td>35</td> <td>289</td> <td>8.26</td> </tr> <tr> <td>DE 11</td> <td>DC 8</td> <td>HM 0</td> <td>OC 0</td> <td>DE 11</td> <td>DC 24</td> <td>HM 0</td> <td>OC 0</td> </tr> <tr> <td>AU 0</td> <td>ES 0</td> <td>BS 0</td> <td>Total 19</td> <td>AU 0</td> <td>ES 0</td> <td>BS 0</td> <td>Total 35</td> </tr> </tbody> </table>				SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA		19	149	7.84		35	289	8.26	DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0	AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35
SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA																																																																
	16	140	8.75		16	140	8.75																																																																
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0																																																																
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16																																																																
SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA																																																																
	19	149	7.84		35	289	8.26																																																																
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0																																																																
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35																																																																

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	AA
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AB
ENL543	NANOPHOTONICS (DE)	3	AB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	12	114	9.50		47	403	8.57
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

Medium of Instruction : English

Abbreviations : Cr - Credits, Gr - Grade, AU - Audit, EGP - Earned Grade Points

SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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( This Statement is subject to correction, if any )

Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : JYOTI PRAKASH

Enrolment No. : MT22MVD005

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2022</b>				<b>SPRING (Jan - May) 2023</b>			
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BB	ENL504	VLSI SYSTEM DESIGN (DE)	3	BB
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB	ENL518	ANALOG IC DESIGN (DC)	4	BB
ENL513	IC DESIGN WITH HDL (DC)	4	BC	ENL520	NANOELECTRONICS (DC)	4	BC
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CC	ENL522	MEMS AND NEMS (DE)	3	AB
				ENL546	EMBEDDED SYSTEMS (DE)	3	BC
				ENP522	MEMS AND NEMS (DE)	1	AB
				ENP546	EMBEDDED SYSTEMS (DE)	1	BB
<b>SGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>SGPA</b>	<b>CGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>CGPA</b>
	<b>16</b>	<b>120</b>	<b>7.50</b>		<b>16</b>	<b>120</b>	<b>7.50</b>
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	AB
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AB
ENL543	NANOPHOTONICS (DE)	3	AB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	<b>12</b>	<b>108</b>	<b>9.00</b>		<b>47</b>	<b>377</b>	<b>8.02</b>
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	<b>19</b>	<b>149</b>	<b>7.84</b>		<b>35</b>	<b>269</b>	<b>7.69</b>
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

Medium of Instruction : English

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SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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( This Statement is subject to correction, if any )

Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : DESABOYANA LAKSHMI KARUNYA

Enrolment No. : MT22MVD006

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2022</b>				<b>SPRING (Jan - May) 2023</b>			
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BB	ENL504	VLSI SYSTEM DESIGN (DE)	3	BB
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB	ENL518	ANALOG IC DESIGN (DC)	4	BB
ENL513	IC DESIGN WITH HDL (DC)	4	BC	ENL520	NANOELECTRONICS (DC)	4	AB
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BC	ENL522	MEMS AND NEMS (DE)	3	AB
				ENL546	EMBEDDED SYSTEMS (DE)	3	BB
				ENP522	MEMS AND NEMS (DE)	1	AB
				ENP546	EMBEDDED SYSTEMS (DE)	1	AB
<b>SGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>SGPA</b>	<b>CGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>CGPA</b>
	<b>16</b>	<b>124</b>	<b>7.75</b>		<b>16</b>	<b>124</b>	<b>7.75</b>
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	AA
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AB
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AA

<b>SGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>SGPA</b>	<b>CGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>CGPA</b>
	<b>12</b>	<b>117</b>	<b>9.75</b>		<b>47</b>	<b>402</b>	<b>8.55</b>
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

<b>SGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>SGPA</b>	<b>CGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>CGPA</b>
	<b>19</b>	<b>161</b>	<b>8.47</b>		<b>35</b>	<b>285</b>	<b>8.14</b>
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

Medium of Instruction : English

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : PALUSA YASHWANTH GOUD

Enrolment No. : MT22MVD007

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2022</b>				<b>SPRING (Jan - May) 2023</b>			
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	CC	ENL504	VLSI SYSTEM DESIGN (DE)	3	CC
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BB	ENL518	ANALOG IC DESIGN (DC)	4	CC
ENL513	IC DESIGN WITH HDL (DC)	4	BC	ENL520	NANOELECTRONICS (DC)	4	CC
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BB	ENL522	MEMS AND NEMS (DE)	3	BC
				ENL542	CMOS RF DESIGN (DE)	3	BC
				ENP522	MEMS AND NEMS (DE)	1	BB
				ENP542	CMOS RF DESIGN (DE)	1	BC
<b>SGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>SGPA</b>	<b>CGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>CGPA</b>
	<b>16</b>	<b>116</b>	<b>7.25</b>		<b>16</b>	<b>116</b>	<b>7.25</b>
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	BB
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AA
ENL543	NANOPHOTONICS (DE)	3	BB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	<b>12</b>	<b>102</b>	<b>8.50</b>		<b>47</b>	<b>341</b>	<b>7.26</b>
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	<b>19</b>	<b>123</b>	<b>6.47</b>		<b>35</b>	<b>239</b>	<b>6.83</b>
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

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SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**



**PROVISIONAL GRADE CARD**

Name : ADIGOPULA YOGA VYSHNAVI

Enrolment No. : MT22MVD008

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2022**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BB
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BC
ENL513	IC DESIGN WITH HDL (DC)	4	BB
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CC

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	16	116	7.25		16	116	7.25
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	AB
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AB
ENL543	NANOPHOTONICS (DE)	3	AB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	12	108	9.00		47	372	7.91
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

**SPRING (Jan - May) 2023**

ENL504	VLSI SYSTEM DESIGN (DE)	3	BB
ENL518	ANALOG IC DESIGN (DC)	4	BB
ENL520	NANOELECTRONICS (DC)	4	BC
ENL522	MEMS AND NEMS (DE)	3	BB
ENL542	CMOS RF DESIGN (DE)	3	BB
ENP522	MEMS AND NEMS (DE)	1	AB
ENP542	CMOS RF DESIGN (DE)	1	BC

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	19	148	7.79		35	264	7.54
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

Medium of Instruction : English

Abbreviations : Cr - Credits, Gr - Grade, AU - Audit, EGP - Earned Grade Points

SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : BOMMA SANDHYA RANI

Enrolment No. : MT22MVD010

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
<b>AUTUMN (July-Nov)2022</b>				<b>SPRING (Jan - May) 2023</b>			
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	CC	ENL504	VLSI SYSTEM DESIGN (DE)	3	CC
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB	ENL518	ANALOG IC DESIGN (DC)	4	BC
ENL513	IC DESIGN WITH HDL (DC)	4	BB	ENL520	NANOELECTRONICS (DC)	4	CC
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CC	ENL522	MEMS AND NEMS (DE)	3	BC
				ENL542	CMOS RF DESIGN (DE)	3	BC
				ENP522	MEMS AND NEMS (DE)	1	BC
				ENP542	CMOS RF DESIGN (DE)	1	CC
<b>SGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>SGPA</b>	<b>SGPA</b>	<b>Credit</b>	<b>EGP</b>	<b>CGPA</b>
	<b>16</b>	<b>116</b>	<b>7.25</b>		<b>16</b>	<b>116</b>	<b>7.25</b>
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	BB
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BB
ENL543	NANOPHOTONICS (DE)	3	BC

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	<b>12</b>	<b>93</b>	<b>7.75</b>		<b>47</b>	<b>334</b>	<b>7.11</b>
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	<b>19</b>	<b>125</b>	<b>6.58</b>		<b>35</b>	<b>241</b>	<b>6.89</b>
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35

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Medium of Instruction : English

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SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : KM PUJA YADAV

Enrolment No. : MT22MVD011

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2022**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	BB
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	BB
ENL513	IC DESIGN WITH HDL (DC)	4	CC
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CC

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	16	112	7.00		16	112	7.00
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	AB
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BB
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AA

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	12	108	9.00		47	362	7.70
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

**SPRING (Jan - May) 2023**

ENL504	VLSI SYSTEM DESIGN (DE)	3	BB
ENL518	ANALOG IC DESIGN (DC)	4	BB
ENL520	NANOELECTRONICS (DC)	4	BC
ENL522	MEMS AND NEMS (DE)	3	BC
ENL542	CMOS RF DESIGN (DE)	3	BC
ENP522	MEMS AND NEMS (DE)	1	BB
ENP542	CMOS RF DESIGN (DE)	1	BB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	19	142	7.47		35	254	7.26
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35

**Note : THIS GRADE CARD IS EXCLUSIVELY FOR INTERNAL USE**

Medium of Instruction : English

Abbreviations : Cr - Credits, Gr - Grade, AU - Audit, EGP - Earned Grade Points

SGPA - Semester Grade Point Average, CGPA - Cumulative Grade Point Average, W - repeat the Course

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( This Statement is subject to correction, if any )

Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : VAMA VEERENDRANATH

Enrolment No. : MT22MVD012

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr
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**AUTUMN (July-Nov)2022**

ENL509	ADVANCED DEVICE PHYSICS (DC)	4	CC
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB
ENL513	IC DESIGN WITH HDL (DC)	4	BC
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	BB

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	16	120	7.50		16	120	7.50
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16

**SPRING (Jan - May) 2023**

ENL504	VLSI SYSTEM DESIGN (DE)	3	AA
ENL518	ANALOG IC DESIGN (DC)	4	AB
ENL520	NANOELECTRONICS (DC)	4	AB
ENL522	MEMS AND NEMS (DE)	3	BB
ENL546	EMBEDDED SYSTEMS (DE)	3	AB
ENP522	MEMS AND NEMS (DE)	1	BB
ENP546	EMBEDDED SYSTEMS (DE)	1	AA

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	19	171	9.00		35	291	8.31
DE 11	DC 8	HM 0	OC 0	DE 11	DC 24	HM 0	OC 0
AU 0	ES 0	BS 0	Total 19	AU 0	ES 0	BS 0	Total 35

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	AB
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	AA
ENL521	REAL TIME SIGNAL PROCESSING (DE)	3	AA

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	12	114	9.50		47	405	8.62
DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**

**PROVISIONAL GRADE CARD**

Name : VARIJ SHUKLA

Enrolment No. : MT22MVD013

Branch : V L S I DESIGN

Degree : Master of Technology

Course	Title	Cr	Gr	Course	Title	Cr	Gr																																
<b>AUTUMN (July-Nov)2022</b>				<b>SPRING (Jan - May) 2023</b>																																			
ENL509	ADVANCED DEVICE PHYSICS (DC)	4	AB	ENL504	VLSI SYSTEM DESIGN (DE)	3	CC																																
ENL511	CMOS DIGITAL VLSI DESIGN (DC)	4	AB	ENL518	ANALOG IC DESIGN (DC)	4	BB																																
ENL513	IC DESIGN WITH HDL (DC)	4	BB	ENL520	NANOELECTRONICS (DC)	4	BC																																
ENL517	MICRO AND NANO FABRICATION TECHNOLOGIES (DC)	4	CC	ENL522	MEMS AND NEMS (DE)	3	BB																																
<table border="1"> <thead> <tr> <th>SGPA</th> <th>Credit</th> <th>EGP</th> <th>SGPA</th> <th>CGPA</th> <th>Credit</th> <th>EGP</th> <th>CGPA</th> </tr> </thead> <tbody> <tr> <td></td> <td>16</td> <td>128</td> <td>8.00</td> <td></td> <td>16</td> <td>128</td> <td>8.00</td> </tr> </tbody> </table>				SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA		16	128	8.00		16	128	8.00	<table border="1"> <thead> <tr> <th>SGPA</th> <th>Credit</th> <th>EGP</th> <th>SGPA</th> <th>CGPA</th> <th>Credit</th> <th>EGP</th> <th>CGPA</th> </tr> </thead> <tbody> <tr> <td></td> <td>19</td> <td>137</td> <td>7.21</td> <td></td> <td>35</td> <td>265</td> <td>7.57</td> </tr> </tbody> </table>				SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA		19	137	7.21		35	265	7.57
SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA																																
	16	128	8.00		16	128	8.00																																
SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA																																
	19	137	7.21		35	265	7.57																																
DE 0	DC 16	HM 0	OC 0	DE 0	DC 16	HM 0	OC 0																																
AU 0	ES 0	BS 0	Total 16	AU 0	ES 0	BS 0	Total 16																																

**AUTUMN (July-Nov)2023**

END501	PROJECT PHASE - I (DC)	6	AB
ENL507	DESIGN FOR TESTABILITY YIELD AND RELIABILITY (DE)	3	BB
ENL543	NANOPHOTONICS (DE)	3	AA

SGPA	Credit	EGP	SGPA	CGPA	Credit	EGP	CGPA
	12	108	9.00		47	373	7.94

DE 6	DC 6	HM 0	OC 0	DE 17	DC 30	HM 0	OC 0
AU 0	ES 0	BS 0	Total 12	AU 0	ES 0	BS 0	Total 47

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Date : 18-Jan-2024

**Asst. Registrar (Examination)**